# **Specification**

Drawing No.	UKY1C-H1-15B83-00[43] 1/11
Issued Date.	Oct.30,2015

TO: Digi-key

Note: In case of specification change, KYOCERA Part Number also will be changed.

Product Name	Quartz Crystal
Product Model	CX3225GB
Frequency	12000kHz
Customer Part Number	-
Customer Specification Number	-
KYOCERA Part Number	CX3225GB12000H0KPSC1
Remarks RoHS Compliant, MSL 1	

#### Customer Acceptance

Accept Signature	Approved Date
	Department
	Person in charge

#### Seller

# **KYOCERA** Crystal Device Corporation

(Sales Division) 6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501 Japan TEL. No. 075-604-3500 FAX. No. 075-604-3501

#### Manufacturer

Crystal Units Division 5850, Higashine-Koh, Higashine-Shi, Yamagata 999-3701 Japan TEL. No. 0237-43-5611 FAX. No. 0237-43-5615

Design Department	Quality Assurance	Approved by	Checked by	Issued by
KYOCERA Crystal Device Corporation Crystal Units Engineering Section Crystal Units Division	T. Noritake	H. Shoji	A. Ito	M.Hashimoto

Drawing No.	UKY1C-H1-15B83-00[43]	2/11
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# **Revision History**

Rev.No.	Description of revise	Date	Approved by	Checked by	Issued by
1	First Edition	Oct.30,2015	H. Shoji	A. Ito	M.Hashimoto

### **1. APPLICATION**

This specification sheet is applied to quartz crystal "CX3225GB12000H0KPSC1"

#### 2. KYOCERA PART NUMBER

CX3225GB12000H0KPSC1

#### 3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature	Topr	-40 to +85	С°	
Storage Temperature Range	Tstg	-40 to +85	C°	

#### 4. CHARACTERISTICS ELECTRICAL CHARACTERISTICS

Items		Electrical Specification				Test Condition	Remarks
	SYMB.	Min.	Тур.	Max.	Unit		
Mode of Vibration			Fundamental				
Nominal	F0		12		MHz		
Frequency							
Nominal	T <sub>NOM</sub>		+25		°C		
Temperature							
Load Capacitance	CL		12.0		pF		
Frequency	df/F	-30.0		+30.0		+25±3°C	
Tolerance							
Frequency	df/F	-50.0		+50.0		-40 to +85°C	
Temperature					PPM		
Characteristics							
Frequency Aging		-5.0		+5.0		1 <sup>st</sup> year	+25±3°C
Rate							
Equivalent Series	ESR			150	Ω		
Resistance							
Drive Level	Pd	0.01		100	μW		
Insulation	IR	500			MΩ	100V(DC)	
Resistance			<u> </u>				

# 5. Measurement Condition

5.1 Frequency measurement

Measuring instrument : I	EC PI-Network Test Fixture
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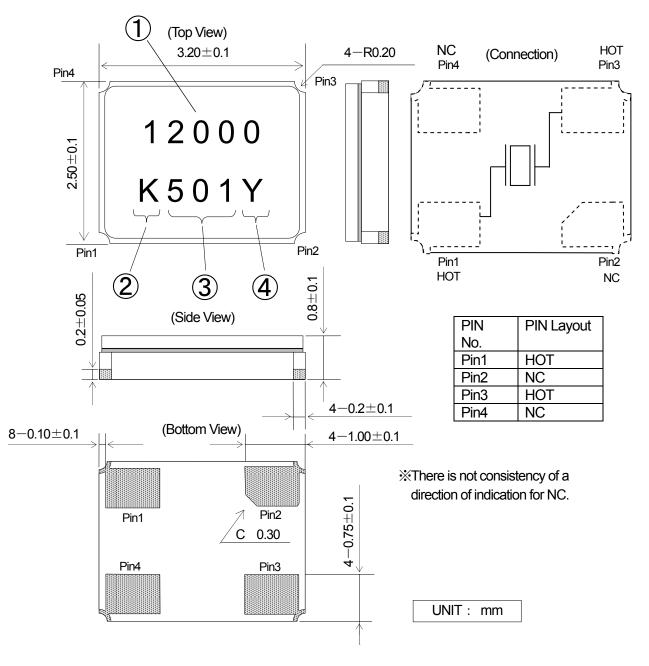
- Load Capacitance : 12.0pF
- : 10µW Drive Level

#### 5.2 Equivalent series resistance (ESR) measurement

Measuring instrument : IEC PI-Network Test Fixture

Load Capacitance : Series : 10µW

Drive Level



#### 6. APPEARANCES, PHYSICAL DIMENSION OUTLINE DIMENSION (not to scale)

#### MARKING

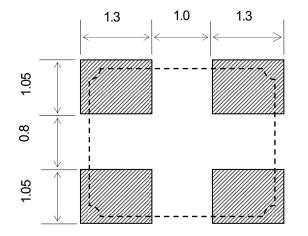
1	Nominal	Frequency
J		i i oquorioj

- 2 Identification
- ③ Date Code

Move the number of maximum indication beams of the frequency to five digits, and omit less than kHz.

- Year···LAST 1 DIGIT of YEAR AND WEEK (Ex) Jan. 1, 2015  $\rightarrow$  501
- (4) Manufacturing Location
- Y…Japan(Yamagata)
- T…Thailand

#### %The font of marking is reference.

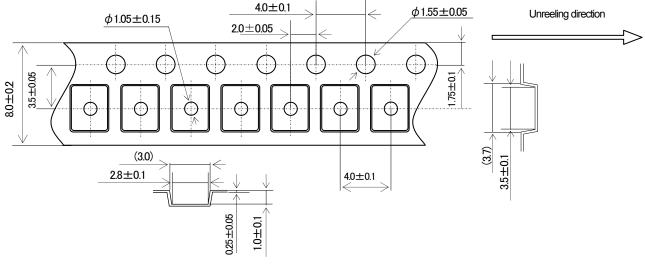


# 7. RECOMMENDED LAND PATTERN (not to scale)

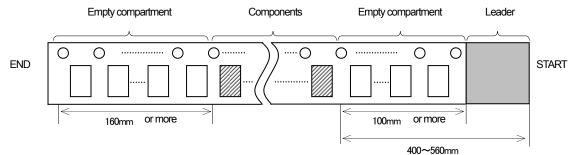
UNIT : mm

#### 8.TAPING & REEL 梱包補助材

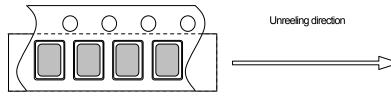
8-1.Dimensions



#### 8-2.Leader and trailer tape



#### 8-3.Direction (The direction shall be seen from the top cover tape side)



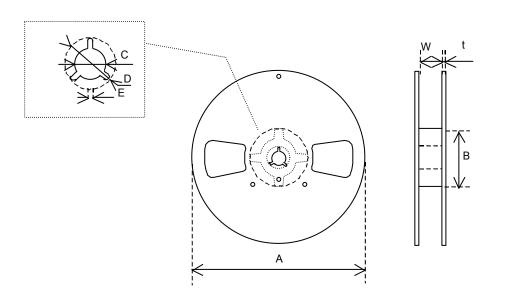
#### 8-4.Specification

- 1. Material of the carrier tape is either polystyrene or A-PET (ESD).
- 2. Material of the cover tape is polyester (ESD).
- 3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
- 4. Tensile strength of carrier tape: 10N or more.
- 5. The R of the corner of each cavity is 0.2RMAX.
- 6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
- 7. Peeling force of cover tape: 0.1 to 1.0N.
- 8. The component will fall out naturally when cover tape is removed and set upside down.
- 9. The marking on parts is not fixed its direction, its electrical characteristic is equal.

<sup>2</sup>Cover tape 165°~180° Career tape ......

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#### 8-5.Reel specifications



(Nonconductor type Reel)

#### Ф180 Reel (3000pcs Max.)

	A	В	С	D
Dimension	φ180 +0/-1.5	φ60 +1/-0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9±1	2.0±0.5	

(Unit:mm)

# 9.Enviromental requirements

After following test, frequency shall not change more than  $\pm 20 \times 10^{-6}$ And CI,  $\pm 20\%$  or  $5\Omega$  of large value.

9.1	Resistance to Shock	Test condition Natural dropped from height 100cm onto hard wood board in 3 times
9.2	Resistance to Vibration	Test conditionfrequency: 10-55 -10 HzAmplitude: 1.5mmCycle time: 15 minutesDirection: X,Y,Z (3direction),2 h each.
9.3	Resistance to Heat	Test condition The quartz crystal unit shall be stored at a temperature of +85±2°C for 500 h. Then it shall be subjected to standard atmospheric conditions for 1 h ,after whichi measurement shall be made.
9.4	Resistance to Cold	Test condition The quartz crystal unit shall be stored at a temperature of $-40\pm2^{\circ}$ C for 500 h. Then it shall be subjected to standard atmospheric conditions for 1 h ,after whichi measurement shall be made.
9.5	Thermal Shock	Test condition The quartz crystal unit shall be subjected to 500 succesive change of temperature cycles , each as shown in table below, Then it shall be subjected to standard atmospheric conditions for 1h, after which measurements shall be made. Cycle $:-40\pm2^{\circ}$ C (30min.) to $25\pm2^{\circ}$ C (5min.) to +85\pm2^{\circ}C (30min.) to $25\pm2^{\circ}$ C (5min.)

9.6 Re	esistance to Moisture	Test o	condition The quartz crystal unit shall be stored at a temperature of $60\pm2^{\circ}$ C wich relative humidity of 90% to 95% for 240 h. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurements shall be made
9.7 So	oldering condition	1.)	Material of solder Kind ··· lead free solder paste

Melting point ··· +220±5°C

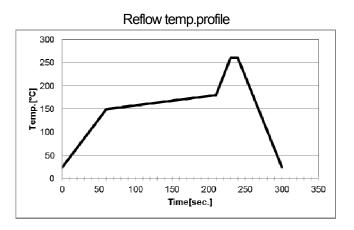
2.) Reflow temp.profile

Temp [°C]	Time[sec]
+150 to +180	150 (typ.)
+260±5	10 (max.)
_	300 (max.)
-	+150 to +180

Frequency shift :  $\pm 2$ ppm

3.) Hand Soldering +350°C 3 sec MAX

4.) Reflow Times 2 times



#### 9.8 Intensity for bending in circuit board

Solder this product in center of the circuit board of 40mm $\times 100$ mm, and add the deflection of 3mm as the bottom figure. Test board : t=1.6mm

#### 10. Cautions for use

(1) Soldering upon mounting

There is a possibility to influence product characteristics when Solder paste or conductive glue comes in contact with product lid or surface.

(2) When using mounting machine

Please minimize the shock when using mounting machine to avoid any excess stress to the product.

(3) Conformity of a circuit

We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 5 times the ESR (Equivalent Series Resistance) of crystal unit.

(4) After making the Quartz Crystal mount on a printed circuit board ,if it is required to divide the printed circuit board into another one, use it with attentive confirmation so that a warp cased by this dividing might not affect any damage. When designing a printed circuit board as well as handling the mounting As much as possible. The quartz crystal shall be passed through the reflow furnace. Then it shall be subjected to standard atmospheric conditions, after which cleaning shall be made.

#### 11. Storage conditions

Please store product in below conditions, and use within 6 months. Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

#### 12. Manufacturing location

Kyocera Crystal Device Corporation / Japan(Yamagata) Kyocera Crystal Device (Thailand) Co., Ltd / Thailand(Lamphun)

### **13. Quality Assurance**

To be guaranteed by Kyocera Crystal Device Quality Assurance Division

#### 14. Quality guarantee

In case when Kyocera Crystal Device Corporation rooted failure occurred within 1year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1year of its delivery is waivered.

#### 15. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.